



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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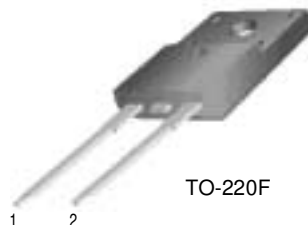
FFPF04F150S

Features

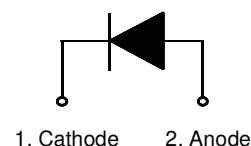
- High voltage and high reliability
- High speed switching
- Low forward voltage

Applications

- Suitable for damper diode in horizontal deflection circuits



TO-220F



DAMPER DIODE

Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Peak Repetitive Reverse Voltage	1500	V
$I_{F(AV)}$	Average Rectified Forward Current @ $T_C = 125^\circ\text{C}$	4	A
I_{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	40	A
T_J, T_{STG}	Operating Junction and Storage Temperature	- 65 to +150	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	5.0	$^\circ\text{C}/\text{W}$

Electrical Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Units	
V_{FM}^*	Maximum Instantaneous Forward Voltage $I_F = 4\text{A}$	$T_C = 25^\circ\text{C}$	-	-	1.5	V
		$T_C = 125^\circ\text{C}$	-	-	1.4	
I_{RM}^*	Maximum Instantaneous Reverse Current @ rated V_R	$T_C = 25^\circ\text{C}$	-	-	5	μA
		$T_C = 125^\circ\text{C}$	-	-	250	
t_{rr}	Maximum Reverse Recovery Time ($I_F = 1\text{A}$, $di/dt = 50\text{A}/\mu\text{s}$)	-	-	170	ns	
t_{fr}	Maximum Forward Recovery Time ($I_F = 6.5\text{A}$, $di/dt = 50\text{A}/\mu\text{s}$)	-	-	450	ns	
V_{FRM}	Maximum Forward Recovery Voltage	-	-	19	V	

* Pulse Test: Pulse Width=300 μs , Duty Cycle=2%

Typical Characteristics

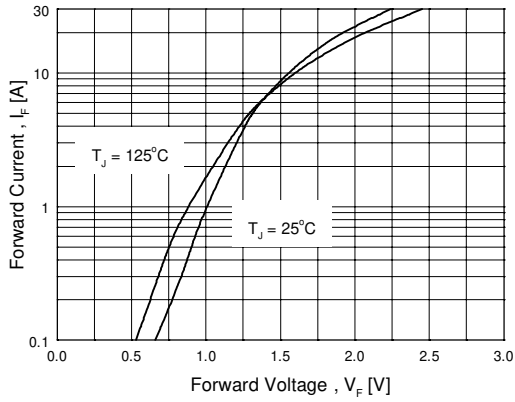


Figure 1. Typical Forward Voltage Drop vs. Forward Current

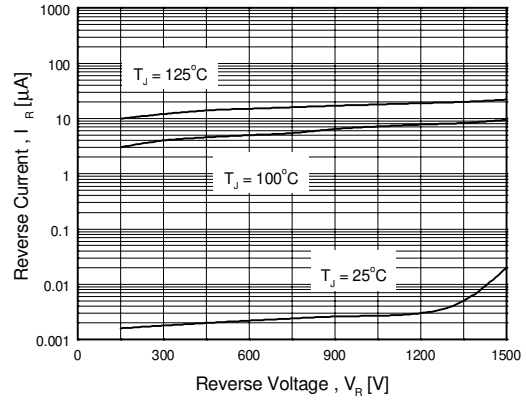


Figure 2. Typical Reverse Current vs. Reverse Voltage

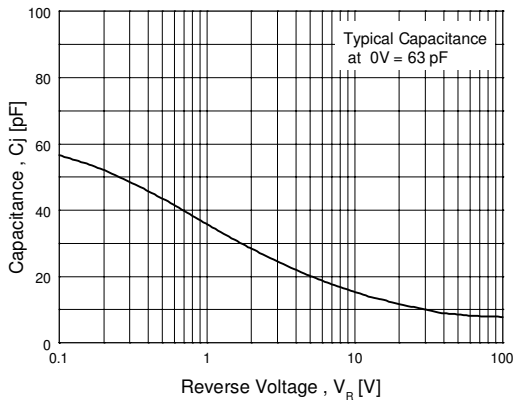


Figure 3. Typical Junction Capacitance

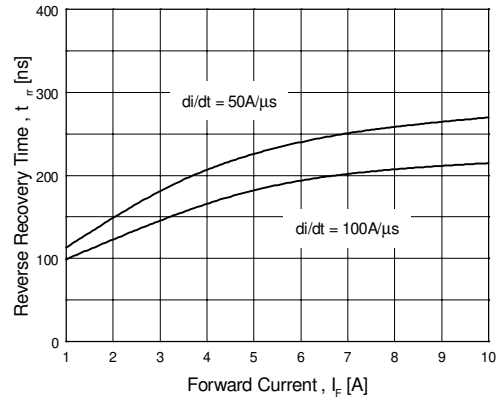


Figure 4. Typical Reverse Recovery Time vs. Forward Current

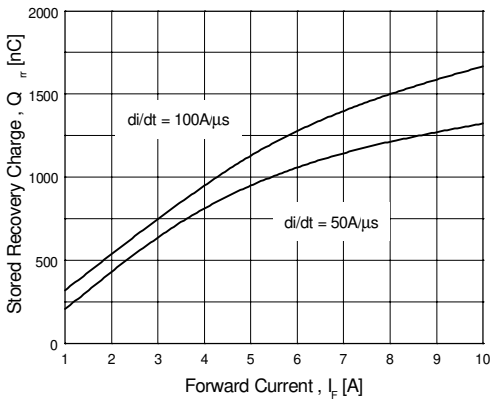


Figure 5. Typical Stored Charge vs. Forward Current

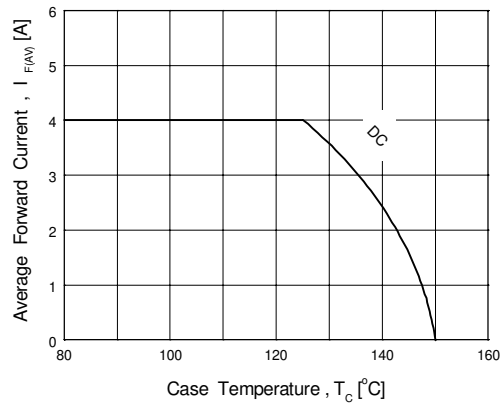
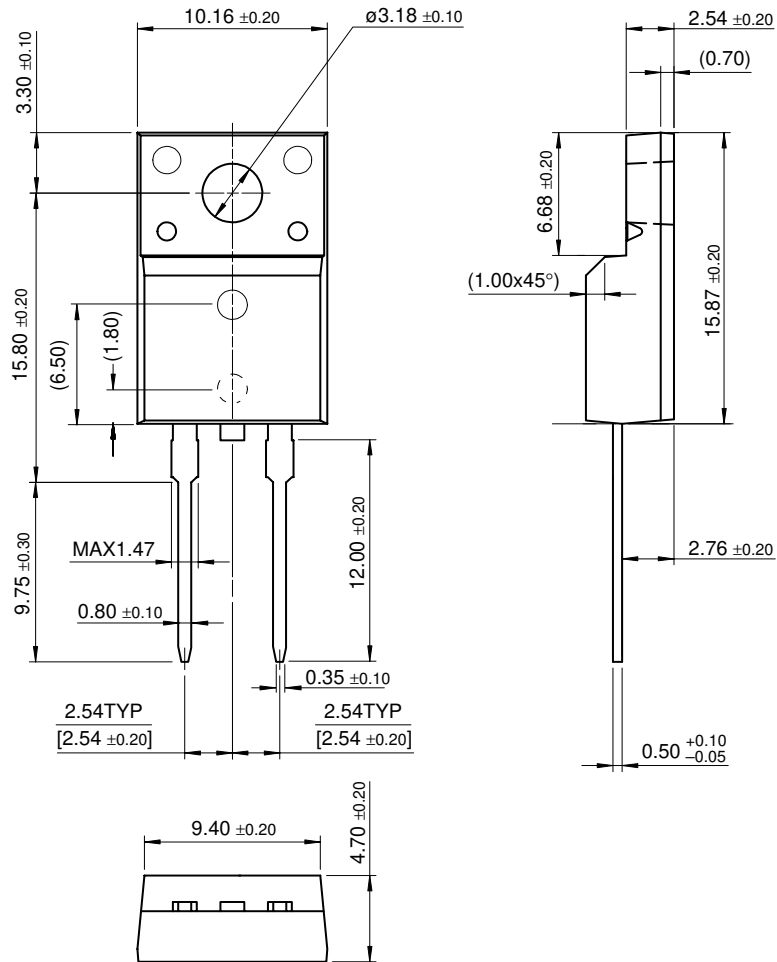


Figure 6. Forward Current Derating Curve

Package Dimensions

TO-220F 2L

FFPF04F150S



Dimensions in Millimeters

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DOME™	ISOPLANAR™	SuperSOT™-3	
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PRODUCT STATUS DEFINITIONS

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